

RTI 900-1161 QFN/LGA POGO PIN SOCKETS



PRODUCT DATA SHEET

PRODUCT OVERVIEW:

The RTI 900-1161 Series pogo pin sockets are designed to meet most low pin count FA or engineering requirements including: bench test, liquid crystal analysis, ESD testing, photo-emission, backside emission, micro-probing, characterization, burn-in, and engineering/production test. Detailed drawings are available upon request.

FEATURES:

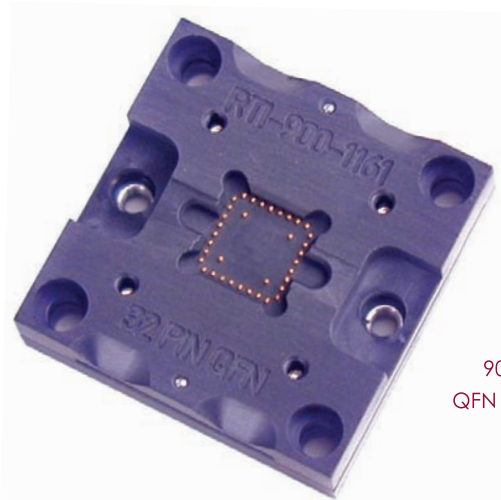
- ◆ Small size: Only 0.9 x 0.9 inches
- ◆ Available for most packages types from 1.0 mm to 10.0 mm body size
- ◆ Two lid styles available
- ◆ Center ground pins if required
- ◆ Available for custom packages and pad configurations
- ◆ Very low profile lid for micro-probing available
- ◆ Available for 0.3mm pitch and greater

AVAILABLE OPTIONS:

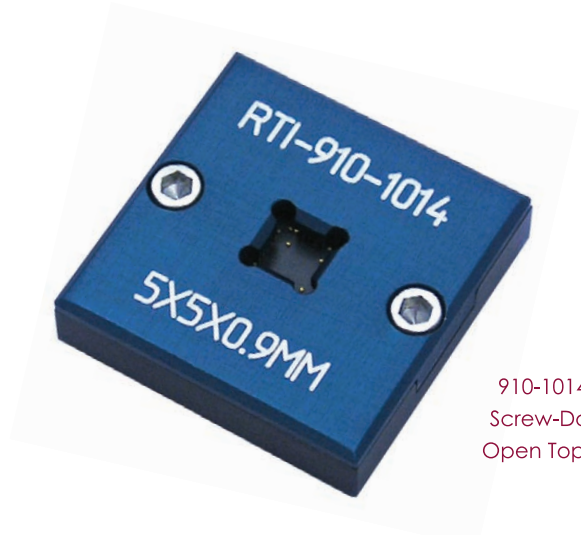
- ◆ Multiple center ground probes
- ◆ Open socket bases for back-side emission
- ◆ Low inductance pins for RF characterization and test
- ◆ Heat sinks in base and lids
- ◆ Low inductance pins for RF characterization and test
- ◆ High force pins for lead-free packages
- ◆ Pockets under sockets for component placement
- ◆ Custom lids available
- ◆ Two standard lid types (both fit the same base)
 - ◆ FA screw-down open top lid: 910-1014
 - ◆ Engineering dual latch lid: 910-1030



910-1030
Clip-On Lid



900-1161
QFN Socket



910-1014 FA
Screw-Down
Open Top Lid